ABSOCIATION CONNECTING ELECTROMICS INDUSTRIES® International and P	IPC, Bannock	burn, Illinois. A	Il rights reserved untions.	under both	This docume level parts, t	ent is a declar he declaratio	ration o on encor	of the substat mpasses all 1	nces wi ower le	thin the manufac vel materials for	turer listed i which the n	tem. No nanufac	ote: if the turer has	item is an as engineering	sembly with low responsibility.
	IPC Web Site for Information on IPC-1752 Standard Form http://www.ipc.org/IPC-175x Distri				be * Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mate					erials and M	rials and Mfg Information				
Supplier Information															
Company name*	Company unique ID				Unique ID Authority					Respons	Response Date*				
nsemi										2024-05-21					
Contact Name	Title - Contact			Phone - Contact*					Email -	Email - Contact*					
Product-Env-Stewards	Product Enviro Compliance				NA					Produc	Product-Env-Stewards@onsemi.com				
uthorized Representative*	Title - Representative			Phone - Representative*				Email -	Email - Representative*						
Product-Env-Stewards		Product Enviro Compliance				NA				Produc	Product-Env-Stewards@onsemi.com				
Requester Item Number	Mfr Iter	n Number	ber Mfr Item Name			Effective Date Version Manufacturing		nufacturing Site	•	Weight*		UOM	Unit Type		
	NC7NZ	17L8X	UHS 3 Buffer Schmitt			2024-05-21			TH	ТНВ		3.4466		mg	Each
Aanufacturing Proccess Inform	ation						1								I
Terminal Plating / Grid Array M	Iaterial '	Terminal Base A	Alloy	J-STD-020 MSL		Peak Process		Body Temperature Max Time at Peal		ak Temperat	Temperature Numbe		Reflow Cyc	les	
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		CU Alloy 1		1		260		С		30		ds 3			
Comments															
evel 1 - maximum time at peak tempera	ture during so	ldering is 10-3	0 seconds												
or more information regarding materia	l composition	please refer to	page 3												

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.1476	mg	Supplier	Silicon (Si)	7440-21-3		0.1476	mg
Die Attach Tape	0.0154	mg	Supplier	Oxirane, (chloromethyl)-, homopolymer	24969-06-0		0.0023	mg
			Supplier	2-Propenoic acid, 2-methyl-, polymer with butyl 2-propenoate and methyl 2- methyl-2-propenoate	25035-69-2		0.0023	mg
			Supplier	Proprietary	Proprietary Data		0.0015	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.0069	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.0023	mg
Lead Frame	1.0344	mg	Supplier	Magnesium (Mg)	7439-95-4		0.0018	mg
			Supplier	Silicon (Si)	7440-21-3		0.0077	mg
			В	Nickel (Ni)	7440-02-0		0.0336	mg
			Supplier	Copper (Cu)	7440-50-8		0.9914	mg
Mold Compound-Black	2.225	mg	Supplier	Epoxy resins	129915-35-1		0.1112	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.1112	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0089	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.0512	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		1.8913	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.0512	mg
Plating	0.0146	mg	Supplier	Palladium (Pd)	7440-05-3		0.0011	mg
			В	Nickel (Ni)	7440-02-0		0.0133	mg
			Supplier	Gold (Au)	7440-57-5		0.0002	mg
Wire Bond	0.0096	mg	Supplier	Palladium (Pd)	7440-05-3		0.0002	mg
			Supplier	Gold (Au)	7440-57-5		0	mg
			Supplier	Copper (Cu)	7440-50-8		0.0094	mg